506249624 09/14/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TOKYO INSTITUTE OF TECHNOLOGY	09/09/2020

RECEIVING PARTY DATA

Name:	SOINN INC.	
Street Address:	4-30, TSURUMA 8-CHOME, MACHIDA-SHI	
City:	TOKYO	
State/Country:	ate/Country: JAPAN	
Postal Code:	194-0004	

PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	9098744

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NAME OF SUBMITTER:	CHRISTOPHER J. MAIER
SIGNATURE: /Christopher J. Maier/ DATE SIGNED: 09/14/2020	

Total Attachments: 1

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PATENT 506249624 REEL: 053760 FRAME: 0013

ASSIGNMENT

Whereas, I, <u>Tokyo Institute of Technology</u> whose post office address appears below, hereinafter referred to as ASSIGNOR, is the owner of certain new and useful improvements in <u>Position Estimation Device</u>, <u>Position Estimation Method</u>, <u>And Program</u> (hereinafter referred to as the INVENTION) for which an application for United States Letters Patent was

:41544	executed on even date herewith	
	executed on:	
X	filed on: January 18, 2013; Issue Date: August 4, 2015;	Serial No.: 13/698,572; Patent No.: 9,098,744
	established by PCT International Patent Application No.	filed:
	designating the United States of America	

WHEREAS, <u>SOINN INC.</u>, whose post office address is <u>4-30</u>, <u>Tsuruma 8-chome</u>, <u>Machida-shi</u>, <u>Tokyo 194-0004</u> <u>Japan</u>, hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I, ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of Maier & Maier, PLLC to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.

Assignor Name	Address
Tokyo Institute of Technology Where Signed	2-12-1, Ookayama, Meguro-ku Tokyo 152-8550, JAPAN
Tokyo, Japan	
Date September 9, 2020	Signature Conn. Mut to Printed Name and Title Osamu WATANABE Director of the Office of Research and Innovation
Witness (optional)	Witness (optional)
Print/Type Name	Print/Type Name
Signature	Signature

PATENT

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